

Freeform Search

Database:	<input type="checkbox"/> US Pre-Grant Publication Full-Text Database <input type="checkbox"/> US Patents Full-Text Database <input type="checkbox"/> US OCR Full-Text Database <input type="checkbox"/> EPO Abstracts Database <input type="checkbox"/> JPO Abstracts Database <input type="checkbox"/> Derwent World Patents Index <input type="checkbox"/> IBM Technical Disclosure Bulletins
Term:	<input type="text" value=" (flowed or flow or flowing) with stream and (pyrolyzed or pyrolyzing or pyrolizing) and laser and (chamber or reaction) and (alumina or"/> <div style="float: right; margin-top: -20px;"> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> </div>
Display:	<input type="text" value="10"/> Documents in Display Format: <input type="text" value="-"/> Starting with Number <input type="text" value="1"/>
Generate: <input type="radio"/> Hit List <input checked="" type="radio"/> Hit Count <input type="radio"/> Side by Side <input type="radio"/> Image	

Search History

DATE: Monday, February 13, 2006 [Printable Copy](#) [Create Case](#)

<u>Set</u> <u>Name</u> <u>Query</u>	<u>Hit</u> <u>Count</u>	<u>Set</u> <u>Name</u> result set
side by side		
<i>DB=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ</i>		
<u>L10</u> (flowed or flow or flowing) with stream and (pyrolyzed or pyrolyzing or pyrolizing) and laser and (chamber or reaction) and (alumina or aluminum oxide or al2o3 or "al.sub.2 o.sub.3")	22	<u>L10</u>
<i>DB=PGPB,USPT,USOC; PLUR=YES; OP=ADJ</i>		
<u>L9</u> (flowed or flow or flowing) with stream and (pyrolyzed or pyrolyzing or pyrolizing) and laser and (chamber or reaction)	40	<u>L9</u>
<i>DB=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ</i>		
<u>L8</u> flow\$ with stream and (pyrolyzed or pyrolyzing or pyrolizing) and laser and (chamber or reaction)	40	<u>L8</u>
<i>DB=PGPB,USPT,USOC; PLUR=YES; OP=ADJ</i>		
<u>L7</u> L6 and (polishing or cmp or polish or planarization or planarizing).ti.	13	<u>L7</u>
<u>L6</u> farkas.in.	884	<u>L6</u>
<u>L5</u> L1 and (cmp or polishing or planarizing or planarization or polish)	400	<u>L5</u>
<u>L4</u> L2 and (cmp or polishing or planarizing or planarization or polish)	0	<u>L4</u>
<i>DB=EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ</i>		

L3 L2 and (cmp or polishing or planarizing or planarization or polish) 4 L3
L2 L1 53 L2
DB=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ
L1 (collection near3 particle or primary near2 (size or diameter) or crystallite
near2 (size or diameter)) with (nm or nanometer) and size near3 distribution 2161 L1

END OF SEARCH HISTORY